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Front Matter: Volume 9013

, "Front Matter: Volume 9013," Proc. SPIE 9013, Three-Dimensional Image Processing, Measurement (3DIPM), and Applications 2014, 901301 (18 March 2014); doi: 10.1117/12.2063063

SPIE.

Event: IS&T/SPIE Electronic Imaging, 2014, San Francisco, California, United States

PROCEEDINGS

Three-Dimensional Image Processing, Measurement (3DIPM), and Applications 2014

Atila M. Baskurt
Robert Sitnik
Editors

5 February 2014
San Francisco, California, United States

Sponsored by
IS&T—The Society for Imaging Science and Technology
SPIE

Published by
SPIE

Volume 9013

Proceedings of SPIE, 0277-786X, v. 9013

Three-Dimensional Image Processing, Measurement (3DIPM), and Applications 2014, edited by Atila M. Baskurt, Robert Sitnik, Proc. of SPIE-IS&T Electronic Imaging, SPIE Vol. 9013, 901301 · © 2014 SPIE-IS&T
CCC code: 0277-786X/14/\$18 · doi: 10.1117/12.2063063

SPIE-IS&T/ Vol. 9013 901301-1

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Author(s), "Title of Paper," in *Three-Dimensional Image Processing, Measurement (3DIPM), and Applications 2014*, edited by Atilla M. Baskurt, Robert Sitnik, Proceedings of SPIE-IS&T Electronic Imaging, SPIE Vol. 9013. Article CID Number (2014)

ISSN: 0277-786X

ISBN: 9780819499301

Copublished by

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Printed in the United States of America.

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